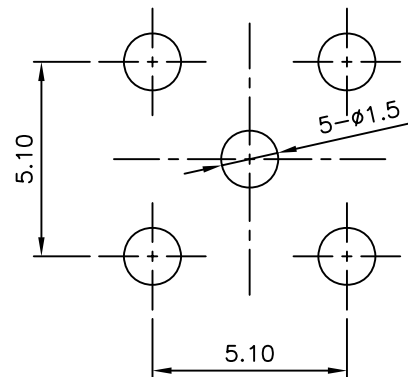
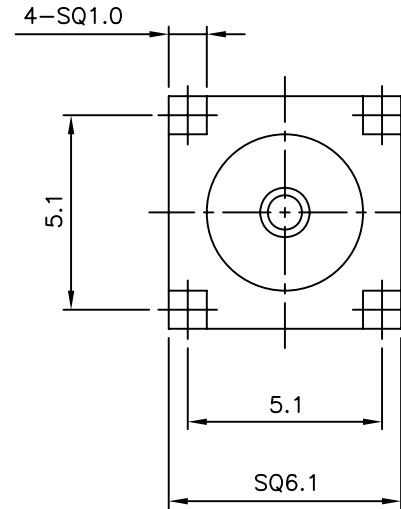
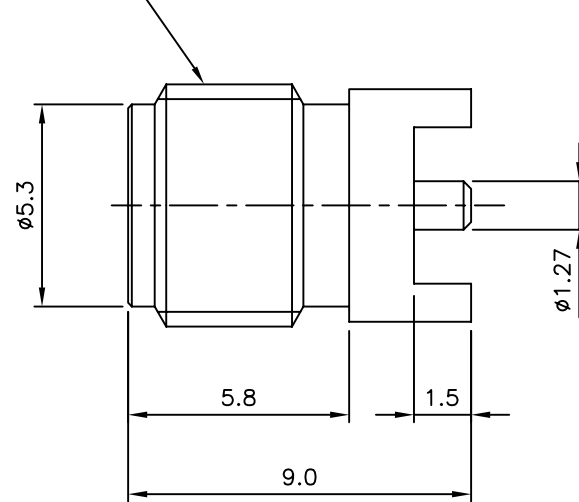


REVISION					
REV	DESCRIPTION		DRAWN	APPR	DATE
IR	Initial Registration		S.Y.EUN	I.C.KIM	2019.12.03.
1	[설번No.201912-0003] 원제품 조립 시 핀 돌출 방지로 인한 치수 수정		S.Y.EUN	I.C.KIM	2019.12.09.

1/4-36 UNS-2A



PCB MOUNT HOLE SIZE

3	INSULATOR	1	TEFLON		DIN02597-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03490-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD03942-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2019. 12. 09.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		TITLE SMA50 PCB JS-4R
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	5/1	DWG NO. CN03428-7/1
		UNIT	mm	
		A4		REVISION 1
				SHEET 1 of 1